

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																				
NATURE OF CONVEYANCE:	ASSIGNMENT																				
CONVEYING PARTY DATA																					
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Samsung SDI Co., Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>428-5, Gongse-dong, Giheung-gu</td> </tr> <tr> <td>City:</td> <td>Yongin-si, Gyeonggi-do</td> </tr> <tr> <td>State/Country:</td> <td>REPUBLIC OF KOREA</td> </tr> </table>		Name:	Samsung SDI Co., Ltd.	Street Address:	428-5, Gongse-dong, Giheung-gu	City:	Yongin-si, Gyeonggi-do	State/Country:	REPUBLIC OF KOREA												
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CORRESPONDENCE DATA																					
<p>Fax Number: (949)760-9502 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 9497600404 Email: efiling@kmob.com Correspondent Name: Knobbe Martens Olson & Bear LLP Address Line 1: 2040 Main Street Address Line 2: 14th Floor Address Line 4: Irvine, CALIFORNIA 92614</p>																					

OP \$40.00 13196251

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PATENT
REEL: 026693 FRAME: 0563

ATTORNEY DOCKET NUMBER:	SDIYPL.397AUS
NAME OF SUBMITTER:	Christopher Sweeney
Total Attachments: 3 source=ExecutedAssignment#page1.tif source=ExecutedAssignment#page2.tif source=ExecutedAssignment#page3.tif	

Application No.: Unknown
Filing Date: Herewith

Client Code: SDIYPL397AUS
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ASSIGNMENT

WHEREAS, I, the undersigned, have invented certain new and useful improvements in a **POSITIVE ACTIVE MATERIAL, METHOD OF PREPARING THE SAME, AND LITHIUM BATTERY INCLUDING THE POSITIVE ACTIVE MATERIAL**; the specification of which was executed on even date herewith.

AND WHEREAS, Samsung SDI Co., Ltd., (hereinafter "ASSIGNEE"), with its principal place of business at 428-5, Gongse-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea, desires to acquire the entire right, title, and interest in and to the said improvements with respect to the United States of America, its territories and possessions.

NOW, THEREFORE, in light of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said inventor, do hereby acknowledge that I have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

Date: 25 / July / 2011

Signature: Hyun-Deok LEE

Name: Hyun-Deok LEE

Address : c/o Samsung SDI Co., Ltd.

428-5, Gongse-dong, Giheung-gu,

Yongin-si, Gyeonggi-do, Republic of Korea

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Date: 25 / July / 2011

Signature: Yong-Chul PARK

Name: Yong-Chul PARK
Address : c/o Samsung SDI Co., Ltd.

428-5, Gongse-dong, Giheung-gu,
Yongin-si, Gyeonggi-do, Republic of Korea

Date: 25 / July / 2011

Signature: Mi-Ran SONG

Name: Mi-Ran SONG
Address : c/o Samsung SDI Co., Ltd.

428-5, Gongse-dong, Giheung-gu,
Yongin-si, Gyeonggi-do, Republic of Korea

Date: 26 / July / 2011

Signature: Na-Leum YOO

Name: Na-Leum YOO
Address : c/o Samsung SDI Co., Ltd.

428-5, Gongse-dong, Giheung-gu,
Yongin-si, Gyeonggi-do, Republic of Korea

Date: 26 / July / 2011

Signature: Jin-Hyoung SEO.

Name: Jin-Hyoung SEO
Address : c/o Samsung SDI Co., Ltd.

428-5, Gongse-dong, Giheung-gu,
Yongin-si, Gyeonggi-do, Republic of Korea

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Date: 25/ July / 2011

Signature: Min-Ju KIM

Name: Min-Ju KIM
Address : c/o Samsung SDI Co., Ltd.

428-5, Gongse-dong, Giheung-gu,
Yongin-si, Gyeonggi-do, Republic of Korea

Date: 25/ July / 2011

Signature: Gyeong-Jae HEO

Name: Gyeong-Jae HEO
Address : c/o Samsung SDI Co., Ltd.

428-5, Gongse-dong, Giheung-gu,
Yongin-si, Gyeonggi-do, Republic of Korea

Date: 25/ July / 2011

Signature: Jae-Dong Byun

Name: Jae-Dong BYUN
Address : 17-779, Sampung Apt., 1685 Seocho 4-dong
Seocho-gu, Seoul, 137-779 Republic of Korea

Date: 25/ July / 2011

Signature: Sun-Youn RYOU

Name: Sun-Youn RYOU
Address 4-806, Sunkyung Apt., 823 Seongjeong 2-dong,
Seobuk-gu, Cheonan-si, Chungcheongnam-do,
331-778 Republic of Korea

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110810